# 74AUP2G00

## Low-power dual 2-input NAND gate

Rev. 14 — 12 August 2024 Product data sheet

## 1. General description

The 74AUP2G00 provides dual 2-input NAND function.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire $V_{CC}$ range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire $V_{CC}$ range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using $I_{OFF}$. The $I_{OFF}$ circuitry disables the output, preventing a damaging backflow current through the device when it is powered down.

## 2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- Low static power consumption; $I_{CC}$ = 0.9 µA (maximum)
- Latch-up performance exceeds 100 mA per JESD78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of $V_{CC}$
- $I_{OFF}$ circuitry provides partial power-down mode operation
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3A exceeds 5000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

# 3. Ordering information

**Table 1. Ordering information**

| Type number | Package | | | |
|---|---|---|---|---|
| | Temperature range | Name | Description | Version |
| 74AUP2G00DC | -40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |
| 74AUP2G00GT | -40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm | SOT833-1 |
| 74AUP2G00GN | -40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm | SOT1116 |
| 74AUP2G00GS | -40 °C to +125 °C | XSON8 | extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm | SOT1203 |
| 74AUP2G00GX | -40 °C to +125 °C | X2SON8 | plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 × 0.8 × 0.32 mm | SOT1233-2 |

# 4. Marking

**Table 2. Marking codes**

| Type number | Marking code[1] |
|---|---|
| 74AUP2G00DC | p00 |
| 74AUP2G00GT | p00 |
| 74AUP2G00GN | pA |
| 74AUP2G00GS | pA |
| 74AUP2G00GX | pA |

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

# 5. Functional diagram

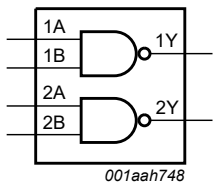



Fig. 1. Logic symbol

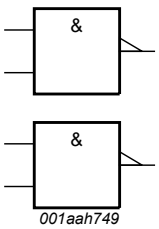



Fig. 2. IEC logic symbol

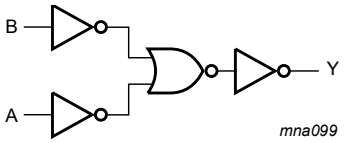
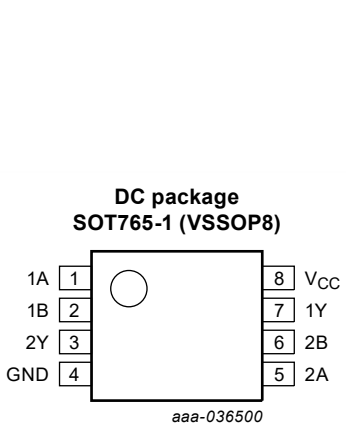
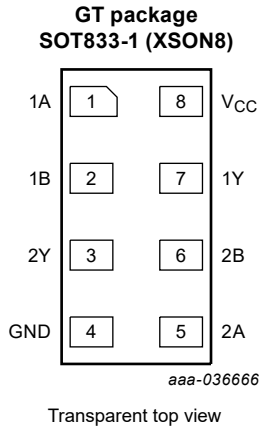



Fig. 3. Logic diagram (one gate)

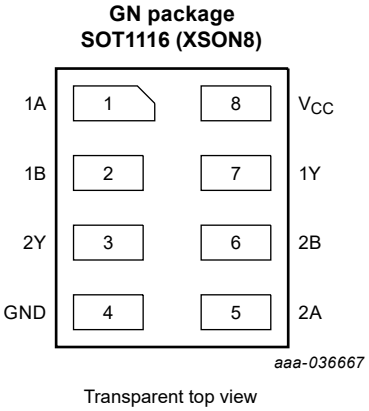
# 6. Pinning information

## 6.1. Pinning

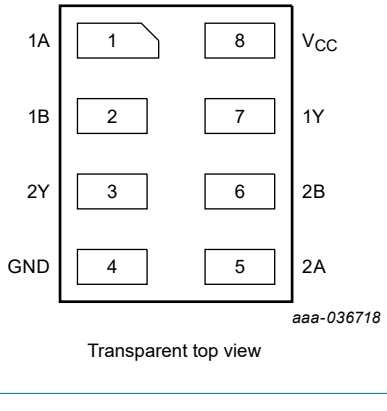


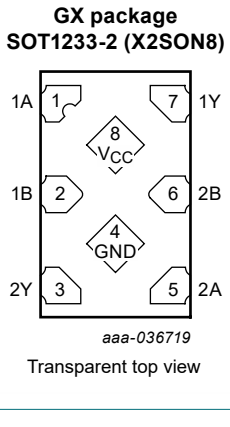

Transparent top view




Transparent top view




Transparent top view




Transparent top view

## 6.2. Pin description

**Table 3. Pin description**

| Symbol | Pin | Description |
|---|---|---|
| 1A, 2A | 1, 5 | data input |
| 1B, 2B | 2, 6 | data input |
| GND | 4 | ground (0 V) |
| 1Y, 2Y | 7, 3 | data output |
| $V_{CC}$ | 8 | supply voltage |

# 7. Functional description

**Table 4. Function table**

*H = HIGH voltage level; L = LOW voltage level.*

| Input | | Output |
|---|---|---|
| **nA** | **nB** | **nY** |
| L | L | H |
| L | H | H |
| H | L | H |
| H | H | L |

# 8. Limiting values

**Table 5. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---|---|---|---|---|---|
| $V_{CC}$ | supply voltage | | -0.5 | +4.6 | V |
| $V_I$ | input voltage | [1] | -0.5 | +4.6 | V |
| $V_O$ | output voltage | Active mode and Power-down mode [1] | -0.5 | +4.6 | V |
| $I_{IK}$ | input clamping current | $V_I < 0$ V | -50 | - | mA |
| $I_{OK}$ | output clamping current | $V_O < 0$ V | -50 | - | mA |
| $I_O$ | output current | $V_O$ = 0 V to $V_{CC}$ | - | ±20 | mA |
| $I_{CC}$ | supply current | | - | +50 | mA |
| $I_{GND}$ | ground current | | -50 | - | mA |
| $T_{stg}$ | storage temperature | | -65 | +150 | °C |
| $P_{tot}$ | total power dissipation | $T_{amb}$ = -40 °C to +125 °C | | | |
| | | SOT765-1 (VSSOP8) [2]<br>SOT833-1 (XSON8)<br>SOT1116 (XSON8)<br>SOT1203 (XSON8) | - | 250 | mW |
| | | SOT1233-2 (X2SON8) [3] | - | 300 | mW |

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT765-1 (VSSOP8) package: $P_{tot}$ derates linearly with 4.9 mW/K above 99 °C.
For SOT833-1 (XSON8) package: $P_{tot}$ derates linearly with 3.1 mW/K above 68 °C.
For SOT1116 (XSON8) package: $P_{tot}$ derates linearly with 4.2 mW/K above 90 °C.
For SOT1203 (XSON8) package: $P_{tot}$ derates linearly with 3.6 mW/K above 81 °C.

[3] For SOT1233-2 (X2SON8) package: $P_{tot}$ derates linearly with 7.7 mW/K above 118 °C.

# 9. Recommended operating conditions

**Table 6. Operating conditions**

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---|---|---|---|---|---|
| $V_{CC}$ | supply voltage | | 0.8 | 3.6 | V |
| $V_I$ | input voltage | | 0 | 3.6 | V |
| $V_O$ | output voltage | Active mode | 0 | $V_{CC}$ | V |
| | | Power-down mode; $V_{CC}$ = 0 V | 0 | 3.6 | V |
| $T_{amb}$ | ambient temperature | | -40 | +125 | °C |
| Δt/ΔV | input transition rise and fall rate | $V_{CC}$ = 0.8 V to 3.6 V | - | 200 | ns/V |

# 10. Static characteristics

**Table 7. Static characteristics**

*At recommended operating conditions; voltages are referenced to GND (ground = 0 V).*

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **$T_{amb}$ = 25 °C** | | | | | | |
| $V_{IH}$ | HIGH-level input voltage | $V_{CC}$ = 0.8 V | 0.70 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | 0.65 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 2.0 | - | - | V |
| $V_{IL}$ | LOW-level input voltage | $V_{CC}$ = 0.8 V | - | - | 0.30 × $V_{CC}$ | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | - | - | 0.35 × $V_{CC}$ | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | - | - | 0.9 | V |
| $V_{OH}$ | HIGH-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = -20 μA; $V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}$ - 0.1 | - | - | V |
| | | $I_O$ = -1.1 mA; $V_{CC}$ = 1.1 V | 0.75 × $V_{CC}$ | - | - | V |
| | | $I_O$ = -1.7 mA; $V_{CC}$ = 1.4 V | 1.11 | - | - | V |
| | | $I_O$ = -1.9 mA; $V_{CC}$ = 1.65 V | 1.32 | - | - | V |
| | | $I_O$ = -2.3 mA; $V_{CC}$ = 2.3 V | 2.05 | - | - | V |
| | | $I_O$ = -3.1 mA; $V_{CC}$ = 2.3 V | 1.9 | - | - | V |
| | | $I_O$ = -2.7 mA; $V_{CC}$ = 3.0 V | 2.72 | - | - | V |
| | | $I_O$ = -4.0 mA; $V_{CC}$ = 3.0 V | 2.6 | - | - | V |
| $V_{OL}$ | LOW-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = 20 μA; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_O$ = 1.1 mA; $V_{CC}$ = 1.1 V | - | - | 0.3 × $V_{CC}$ | V |
| | | $I_O$ = 1.7 mA; $V_{CC}$ = 1.4 V | - | - | 0.31 | V |
| | | $I_O$ = 1.9 mA; $V_{CC}$ = 1.65 V | - | - | 0.31 | V |
| | | $I_O$ = 2.3 mA; $V_{CC}$ = 2.3 V | - | - | 0.31 | V |
| | | $I_O$ = 3.1 mA; $V_{CC}$ = 2.3 V | - | - | 0.44 | V |
| | | $I_O$ = 2.7 mA; $V_{CC}$ = 3.0 V | - | - | 0.31 | V |
| | | $I_O$ = 4.0 mA; $V_{CC}$ = 3.0 V | - | - | 0.44 | V |
| $I_I$ | input leakage current | $V_I$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V | - | - | ±0.1 | μA |
| $I_{OFF}$ | power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V | - | - | ±0.2 | μA |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $\Delta I_{OFF}$ | additional power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V to 0.2 V | - | - | ±0.2 | µA |
| $I_{CC}$ | supply current | $V_I$ = GND or $V_{CC}$; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.5 | µA |
| $\Delta I_{CC}$ | additional supply current | $V_I$ = $V_{CC}$ - 0.6 V; $I_O$ = 0 A; $V_{CC}$ = 3.3 V; per pin [1] | - | - | 40 | µA |
| $C_I$ | input capacitance | $V_{CC}$ = 0 V to 3.6 V; $V_I$ = GND or $V_{CC}$ | - | 0.8 | - | pF |
| $C_O$ | output capacitance | $V_O$ = GND; $V_{CC}$ = 0 V | - | 1.7 | - | pF |
| **$T_{amb}$ = -40 °C to +85 °C** | | | | | | |
| $V_{IH}$ | HIGH-level input voltage | $V_{CC}$ = 0.8 V | 0.70 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | 0.65 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 2.0 | - | - | V |
| $V_{IL}$ | LOW-level input voltage | $V_{CC}$ = 0.8 V | - | - | 0.30 × $V_{CC}$ | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | - | - | 0.35 × $V_{CC}$ | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | - | - | 0.9 | V |
| $V_{OH}$ | HIGH-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = -20 µA; $V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}$ - 0.1 | - | - | V |
| | | $I_O$ = -1.1 mA; $V_{CC}$ = 1.1 V | 0.7 × $V_{CC}$ | - | - | V |
| | | $I_O$ = -1.7 mA; $V_{CC}$ = 1.4 V | 1.03 | - | - | V |
| | | $I_O$ = -1.9 mA; $V_{CC}$ = 1.65 V | 1.30 | - | - | V |
| | | $I_O$ = -2.3 mA; $V_{CC}$ = 2.3 V | 1.97 | - | - | V |
| | | $I_O$ = -3.1 mA; $V_{CC}$ = 2.3 V | 1.85 | - | - | V |
| | | $I_O$ = -2.7 mA; $V_{CC}$ = 3.0 V | 2.67 | - | - | V |
| | | $I_O$ = -4.0 mA; $V_{CC}$ = 3.0 V | 2.55 | - | - | V |
| $V_{OL}$ | LOW-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = 20 µA; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | $I_O$ = 1.1 mA; $V_{CC}$ = 1.1 V | - | - | 0.3 × $V_{CC}$ | V |
| | | $I_O$ = 1.7 mA; $V_{CC}$ = 1.4 V | - | - | 0.37 | V |
| | | $I_O$ = 1.9 mA; $V_{CC}$ = 1.65 V | - | - | 0.35 | V |
| | | $I_O$ = 2.3 mA; $V_{CC}$ = 2.3 V | - | - | 0.33 | V |
| | | $I_O$ = 3.1 mA; $V_{CC}$ = 2.3 V | - | - | 0.45 | V |
| | | $I_O$ = 2.7 mA; $V_{CC}$ = 3.0 V | - | - | 0.33 | V |
| | | $I_O$ = 4.0 mA; $V_{CC}$ = 3.0 V | - | - | 0.45 | V |
| $I_I$ | input leakage current | $V_I$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V | - | - | ±0.5 | µA |
| $I_{OFF}$ | power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V | - | - | ±0.5 | µA |
| $\Delta I_{OFF}$ | additional power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V to 0.2 V | - | - | ±0.6 | µA |
| $I_{CC}$ | supply current | $V_I$ = GND or $V_{CC}$; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.9 | µA |
| $\Delta I_{CC}$ | additional supply current | $V_I$ = $V_{CC}$ - 0.6 V; $I_O$ = 0 A; $V_{CC}$ = 3.3 V; per pin [1] | - | - | 50 | µA |

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **$T_{amb}$ = -40 °C to +125 °C** | | | | | | |
| $V_{IH}$ | HIGH-level input voltage | $V_{CC}$ = 0.8 V | 0.75 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | 0.70 × $V_{CC}$ | - | - | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 2.0 | - | - | V |
| $V_{IL}$ | LOW-level input voltage | $V_{CC}$ = 0.8 V | - | - | 0.25 × $V_{CC}$ | V |
| | | $V_{CC}$ = 0.9 V to 1.95 V | - | - | 0.30 × $V_{CC}$ | V |
| | | $V_{CC}$ = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | $V_{CC}$ = 3.0 V to 3.6 V | - | - | 0.9 | V |
| $V_{OH}$ | HIGH-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = -20 µA; $V_{CC}$ = 0.8 V to 3.6 V | $V_{CC}$ - 0.11 | - | - | V |
| | | $I_O$ = -1.1 mA; $V_{CC}$ = 1.1 V | 0.6 × $V_{CC}$ | - | - | V |
| | | $I_O$ = -1.7 mA; $V_{CC}$ = 1.4 V | 0.93 | - | - | V |
| | | $I_O$ = -1.9 mA; $V_{CC}$ = 1.65 V | 1.17 | - | - | V |
| | | $I_O$ = -2.3 mA; $V_{CC}$ = 2.3 V | 1.77 | - | - | V |
| | | $I_O$ = -3.1 mA; $V_{CC}$ = 2.3 V | 1.67 | - | - | V |
| | | $I_O$ = -2.7 mA; $V_{CC}$ = 3.0 V | 2.40 | - | - | V |
| | | $I_O$ = -4.0 mA; $V_{CC}$ = 3.0 V | 2.30 | - | - | V |
| $V_{OL}$ | LOW-level output voltage | $V_I$ = $V_{IH}$ or $V_{IL}$ | | | | |
| | | $I_O$ = 20 µA; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 0.11 | V |
| | | $I_O$ = 1.1 mA; $V_{CC}$ = 1.1 V | - | - | 0.33 × $V_{CC}$ | V |
| | | $I_O$ = 1.7 mA; $V_{CC}$ = 1.4 V | - | - | 0.41 | V |
| | | $I_O$ = 1.9 mA; $V_{CC}$ = 1.65 V | - | - | 0.39 | V |
| | | $I_O$ = 2.3 mA; $V_{CC}$ = 2.3 V | - | - | 0.36 | V |
| | | $I_O$ = 3.1 mA; $V_{CC}$ = 2.3 V | - | - | 0.50 | V |
| | | $I_O$ = 2.7 mA; $V_{CC}$ = 3.0 V | - | - | 0.36 | V |
| | | $I_O$ = 4.0 mA; $V_{CC}$ = 3.0 V | - | - | 0.50 | V |
| $I_I$ | input leakage current | $V_I$ = GND to 3.6 V; $V_{CC}$ = 0 V to 3.6 V | - | - | ±0.75 | µA |
| $I_{OFF}$ | power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V | - | - | ±0.75 | µA |
| $\Delta I_{OFF}$ | additional power-off leakage current | $V_I$ or $V_O$ = 0 V to 3.6 V; $V_{CC}$ = 0 V to 0.2 V | - | - | ±0.75 | µA |
| $I_{CC}$ | supply current | $V_I$ = GND or $V_{CC}$; $I_O$ = 0 A; $V_{CC}$ = 0.8 V to 3.6 V | - | - | 1.4 | µA |
| $\Delta I_{CC}$ | additional supply current | $V_I$ = $V_{CC}$ - 0.6 V; $I_O$ = 0 A; $V_{CC}$ = 3.3 V; per pin [1] | - | - | 75 | µA |

[1] One input at $V_{CC}$ - 0.6 V, other input at $V_{CC}$ or GND.

# 11. Dynamic characteristics

**Table 8. Dynamic characteristics**

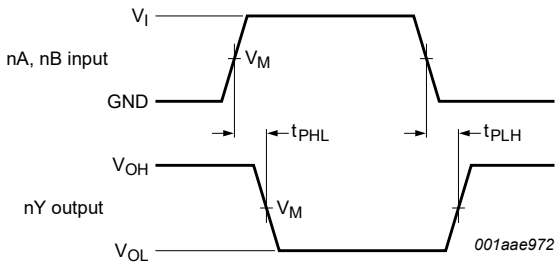
*Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5.*

| Symbol | Parameter | Conditions | $T_{amb}$ = 25 °C | | | $T_{amb}$ = -40 °C to +85 °C | | $T_{amb}$ = -40 °C to +125 °C | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | Min | Typ[1] | Max | Min | Max | Min | Max | |
| **$C_L$ = 5 pF** | | | | | | | | | | |
| $t_{pd}$ | propagation delay | nA, nB to nY; see Fig. 4 [2] | | | | | | | | |
| | | $V_{CC}$ = 0.8 V | - | 17.5 | - | - | - | - | - | ns |
| | | $V_{CC}$ = 1.1 V to 1.3 V | 2.5 | 5.3 | 11.0 | 2.1 | 12.2 | 2.1 | 13.5 | ns |
| | | $V_{CC}$ = 1.4 V to 1.6 V | 2.0 | 3.8 | 6.8 | 1.8 | 7.8 | 1.8 | 8.6 | ns |
| | | $V_{CC}$ = 1.65 V to 1.95 V | 1.6 | 3.1 | 5.3 | 1.4 | 6.2 | 1.4 | 6.9 | ns |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.3 | 2.5 | 4.0 | 1.1 | 4.7 | 1.1 | 5.2 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.0 | 2.2 | 3.6 | 1.0 | 4.2 | 1.0 | 4.7 | ns |
| **$C_L$ = 10 pF** | | | | | | | | | | |
| $t_{pd}$ | propagation delay | nA, nB to nY; see Fig. 4 [2] | | | | | | | | |
| | | $V_{CC}$ = 0.8 V | - | 21.0 | - | - | - | - | - | ns |
| | | $V_{CC}$ = 1.1 V to 1.3 V | 2.4 | 6.1 | 13.0 | 2.2 | 14.4 | 2.2 | 15.9 | ns |
| | | $V_{CC}$ = 1.4 V to 1.6 V | 2.4 | 4.4 | 7.9 | 2.2 | 9.2 | 2.2 | 10.2 | ns |
| | | $V_{CC}$ = 1.65 V to 1.95 V | 2.0 | 3.7 | 6.2 | 1.9 | 7.3 | 1.9 | 8.1 | ns |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.4 | 3.0 | 4.7 | 1.3 | 5.6 | 1.3 | 6.2 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.3 | 2.8 | 4.3 | 1.2 | 4.9 | 1.2 | 5.4 | ns |
| **$C_L$ = 15 pF** | | | | | | | | | | |
| $t_{pd}$ | propagation delay | nA, nB to nY; see Fig. 4 [2] | | | | | | | | |
| | | $V_{CC}$ = 0.8 V | - | 24.5 | - | - | - | - | - | ns |
| | | $V_{CC}$ = 1.1 V to 1.3 V | 3.4 | 6.9 | 14.8 | 3.1 | 16.5 | 3.1 | 18.2 | ns |
| | | $V_{CC}$ = 1.4 V to 1.6 V | 2.8 | 5.0 | 8.9 | 2.5 | 10.5 | 2.5 | 11.6 | ns |
| | | $V_{CC}$ = 1.65 V to 1.95 V | 2.0 | 4.1 | 7.0 | 2.0 | 8.3 | 2.0 | 9.2 | ns |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 1.7 | 3.5 | 5.3 | 1.5 | 6.4 | 1.5 | 7.1 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 1.6 | 3.2 | 4.9 | 1.4 | 5.7 | 1.4 | 6.3 | ns |
| **$C_L$ = 30 pF** | | | | | | | | | | |
| $t_{pd}$ | propagation delay | nA, nB to nY; see Fig. 4 [2] | | | | | | | | |
| | | $V_{CC}$ = 0.8 V | - | 34.8 | - | - | - | - | - | ns |
| | | $V_{CC}$ = 1.1 V to 1.3 V | 4.6 | 9.2 | 20.1 | 4.1 | 22.6 | 4.1 | 24.9 | ns |
| | | $V_{CC}$ = 1.4 V to 1.6 V | 3.0 | 6.5 | 11.8 | 2.9 | 14.0 | 2.9 | 15.4 | ns |
| | | $V_{CC}$ = 1.65 V to 1.95 V | 2.6 | 5.4 | 9.3 | 2.3 | 11.1 | 2.3 | 12.3 | ns |
| | | $V_{CC}$ = 2.3 V to 2.7 V | 2.4 | 4.6 | 7.1 | 2.1 | 8.5 | 2.1 | 9.4 | ns |
| | | $V_{CC}$ = 3.0 V to 3.6 V | 2.3 | 4.3 | 6.5 | 2.1 | 7.6 | 2.1 | 8.4 | ns |

| Symbol | Parameter | Conditions | $T_{amb}$ = 25 °C | | | $T_{amb}$ = -40 °C to +85 °C | | $T_{amb}$ = -40 °C to +125 °C | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | Min | Typ[1] | Max | Min | Max | Min | Max | |
| **$C_L$ = 5 pF, 10 pF, 15 pF and 30 pF** | | | | | | | | | | |
| $C_{PD}$ | power dissipation capacitance | $f_i$ = 1 MHz; $V_I$ = GND to $V_{CC}$ [3] | | | | | | | | |
| | | $V_{CC}$ = 0.8 V | - | 2.8 | - | - | - | - | - | pF |
| | | $V_{CC}$ = 1.1 V to 1.3 V | - | 2.9 | - | - | - | - | - | pF |
| | | $V_{CC}$ = 1.4 V to 1.6 V | - | 3.0 | - | - | - | - | - | pF |
| | | $V_{CC}$ = 1.65 V to 1.95 V | - | 3.0 | - | - | - | - | - | pF |
| | | $V_{CC}$ = 2.3 V to 2.7 V | - | 3.4 | - | - | - | - | - | pF |
| | | $V_{CC}$ = 3.0 V to 3.6 V | - | 3.9 | - | - | - | - | - | pF |

[1] All typical values are measured at nominal $V_{CC}$.
[2] $t_{pd}$ is the same as $t_{PLH}$ and $t_{PHL}$.
[3] $C_{PD}$ is used to determine the dynamic power dissipation ($P_D$ in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
$f_i$ = input frequency in MHz;
$f_o$ = output frequency in MHz;
$C_L$ = output load capacitance in pF;
$V_{CC}$ = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

## 11.1. Waveform and test circuit

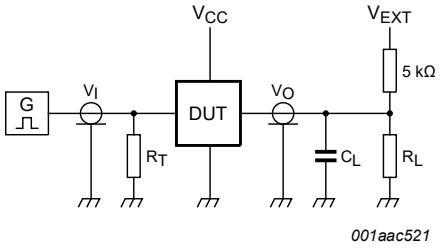



Measurement points are given in Table 9.
Logic levels: $V_{OL}$ and $V_{OH}$ are typical output voltage levels that occur with the output load.

**Fig. 4. The data input (nA or nB) to output (nY) propagation delays**

**Table 9. Measurement points**

| Supply voltage | Output | Input | | |
|---|---|---|---|---|
| $V_{CC}$ | $V_M$ | $V_M$ | $V_I$ | $t_r = t_f$ |
| 0.8 V to 3.6 V | 0.5 × $V_{CC}$ | 0.5 × $V_{CC}$ | $V_{CC}$ | ≤ 3.0 ns |




Test data is given in Table 10.

Definitions for test circuit:

$R_L$ = Load resistance.

$C_L$ = Load capacitance including jig and probe capacitance.

$R_T$ = Termination resistance should be equal to the output impedance Zo of the pulse generator.

$V_{EXT}$ = External voltage for measuring switching times.

**Fig. 5. Test circuit for measuring switching times**

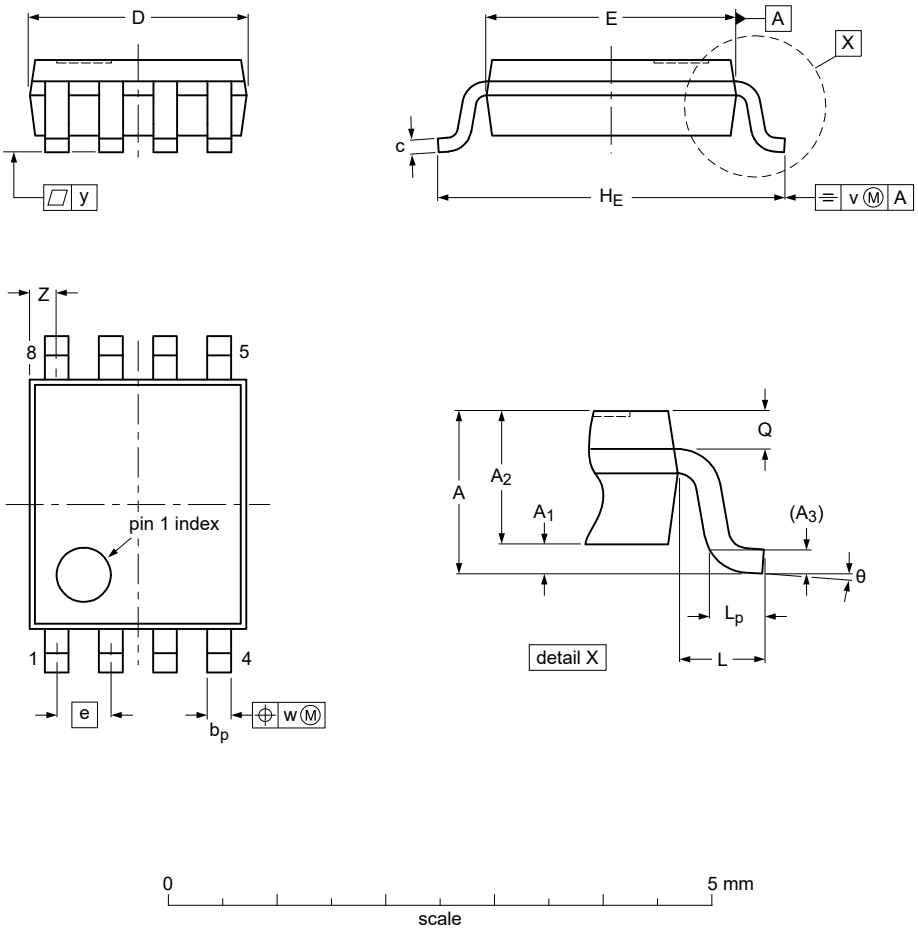
**Table 10. Test data**

| Supply voltage | Load | | $V_{EXT}$ | | |
|---|---|---|---|---|---|
| $V_{CC}$ | $C_L$ | $R_L$ [1] | $t_{PLH}$, $t_{PHL}$ | $t_{PZH}$, $t_{PHZ}$ | $t_{PZL}$, $t_{PLZ}$ |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 kΩ or 1 MΩ | open | GND | 2 × $V_{CC}$ |

[1] For measuring enable and disable times $R_L$ = 5 kΩ.
For measuring propagation delays, setup and hold times and pulse width $R_L$ = 1 MΩ.

## 12. Package outline

**VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm** **SOT765-1**




Dimensions (mm are the original dimensions)

| Unit | A max. | $A_1$ | $A_2$ | $A_3$ | $b_p$ | c | $D^{(1)}$ | $E^{(2)}$ | e | $H_E$ | L | $L_p$ | Q | v | w | y | $Z^{(1)}$ | θ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| max | | 0.15 | 0.85 | | 0.27 | 0.23 | 2.1 | 2.4 | | 3.2 | | 0.40 | 0.21 | | | | 0.4 | 8° |
| mm nom | 1 | | | 0.12 | | | | | 0.5 | | 0.4 | | | 0.2 | 0.08 | 0.1 | | |
| min | | 0.00 | 0.60 | | 0.17 | 0.08 | 1.9 | 2.2 | | 3.0 | | 0.15 | 0.19 | | | | 0.1 | 0° |

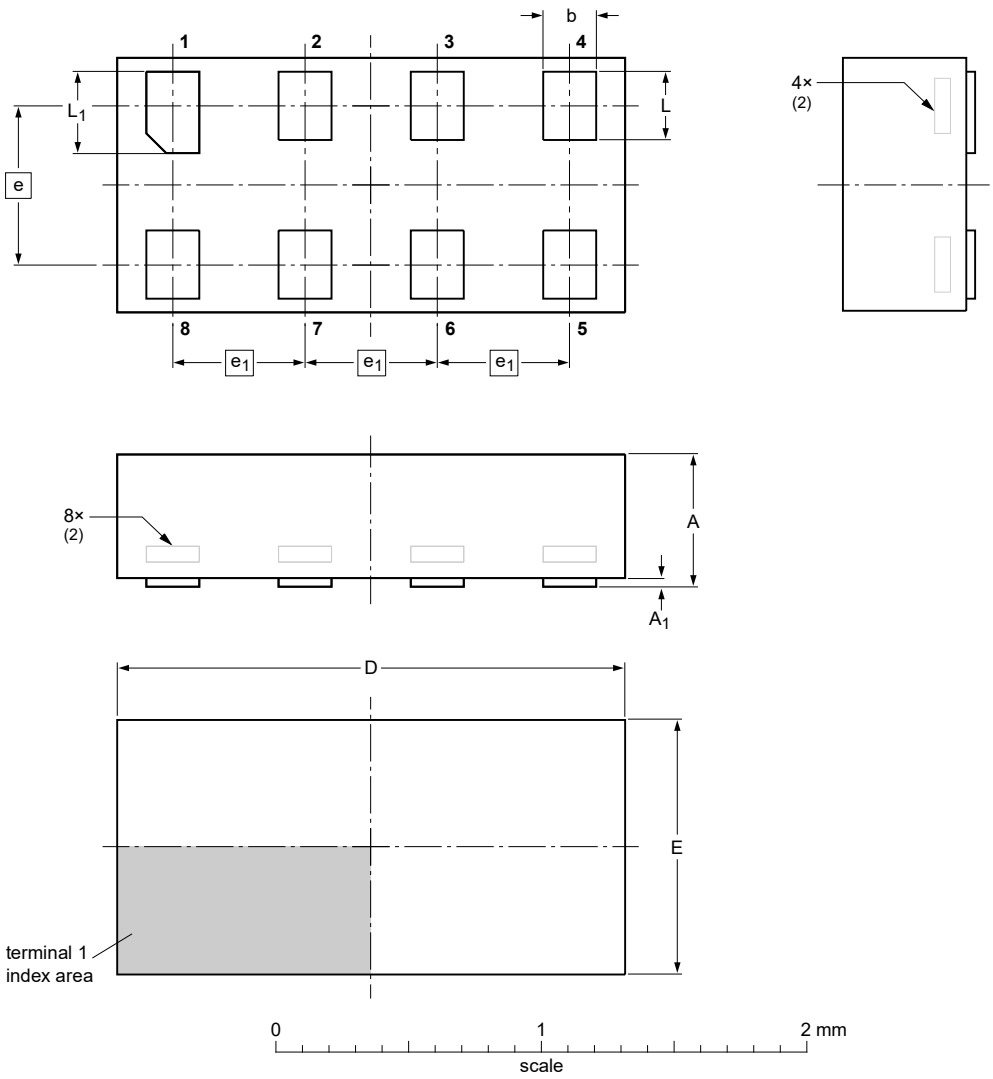
Note
1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

*sot765-1_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT765-1 | | MO-187 | | | | ~~07-06-02~~ 16-05-31 |

**Fig. 6. Package outline SOT765-1 (VSSOP8)**

**XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm** **SOT833-1**




**DIMENSIONS (mm are the original dimensions)**

| UNIT | A(1) max | $A_1$ max | b | D | E | e | $e_1$ | L | $L_1$ |
|---|---|---|---|---|---|---|---|---|---|
| mm | 0.5 | 0.04 | 0.25<br>0.17 | 2.0<br>1.9 | 1.05<br>0.95 | 0.6 | 0.5 | 0.35<br>0.27 | 0.40<br>0.32 |

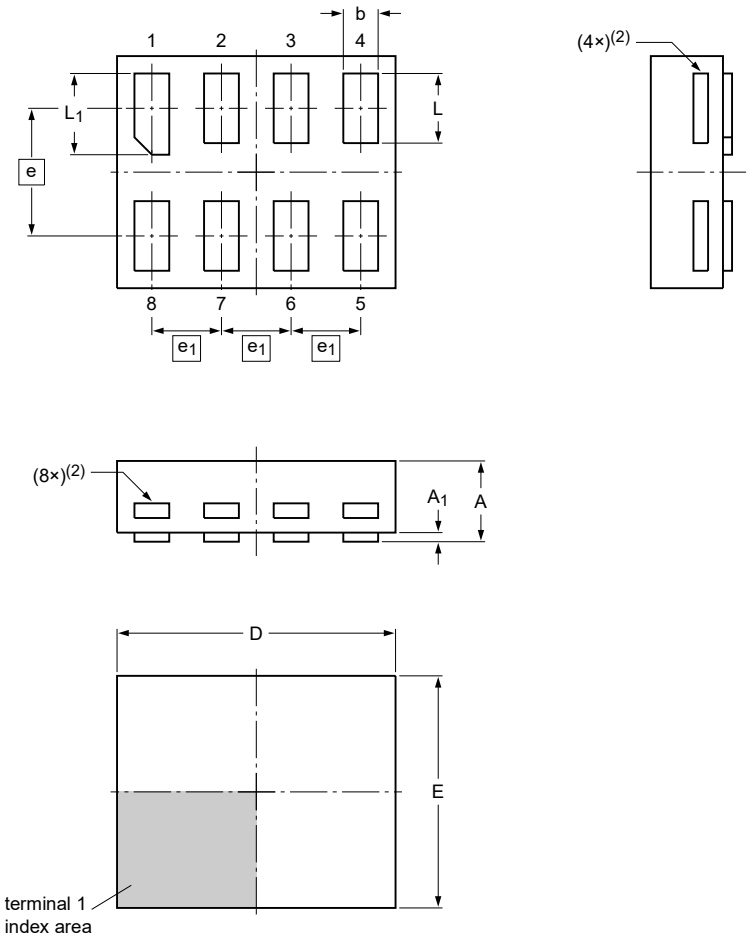
**Notes**

1. Including plating thickness.
2. Can be visible in some manufacturing processes.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT833-1 | - - - | MO-252 | - - - | | | ~~07-11-14~~<br>07-12-07 |

**Fig. 7. Package outline SOT833-1 (XSON8)**

**XSON8: extremely thin small outline package; no leads;**
**8 terminals; body 1.2 x 1.0 x 0.35 mm** **SOT1116**




Dimensions

| Unit | | A(1) | $A_1$ | b | D | E | e | $e_1$ | L | $L_1$ |
|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 0.35 | 0.04 | 0.20 | 1.25 | 1.05 | | | 0.35 | 0.40 |
| | nom | | | 0.15 | 1.20 | 1.00 | 0.55 | 0.3 | 0.30 | 0.35 |
| | min | | | 0.12 | 1.15 | 0.95 | | | 0.27 | 0.32 |

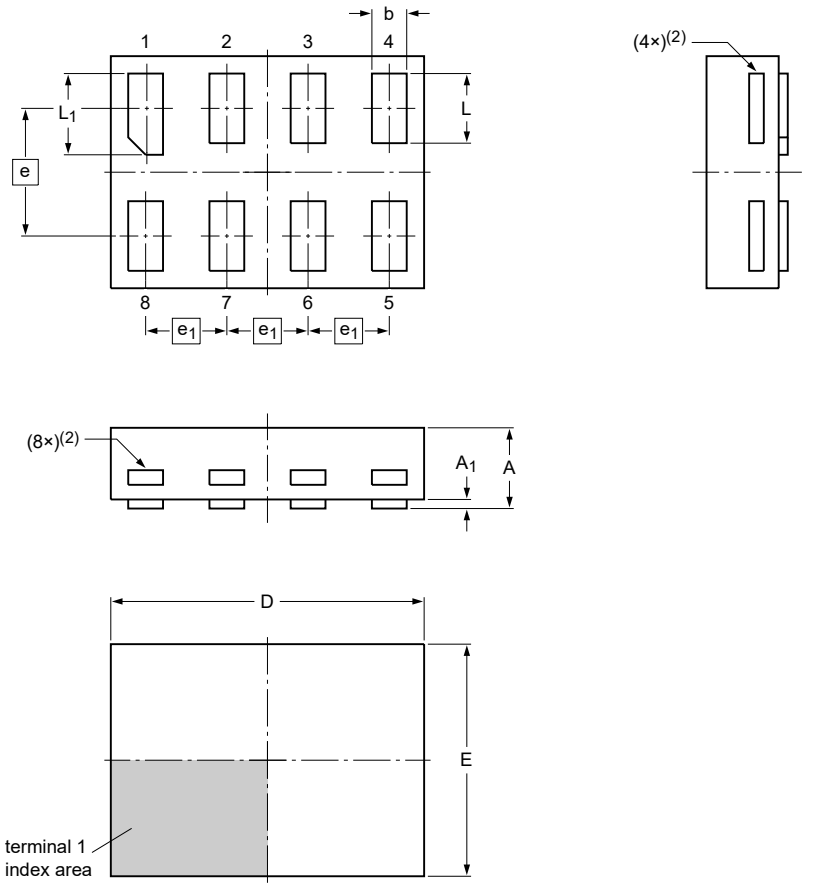
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1116_po

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT1116 | | | | | | ~~10-04-02~~ 10-04-07 |

**Fig. 8. Package outline SOT1116 (XSON8)**

**XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1.0 x 0.35 mm** **SOT1203**




Dimensions

| Unit | | $A^{(1)}$ | $A_1$ | b | D | E | e | $e_1$ | L | $L_1$ |
|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 0.35 | 0.04 | 0.20 | 1.40 | 1.05 | | | 0.35 | 0.40 |
| | nom | | | 0.15 | 1.35 | 1.00 | 0.55 | 0.35 | 0.30 | 0.35 |
| | min | | | 0.12 | 1.30 | 0.95 | | | 0.27 | 0.32 |

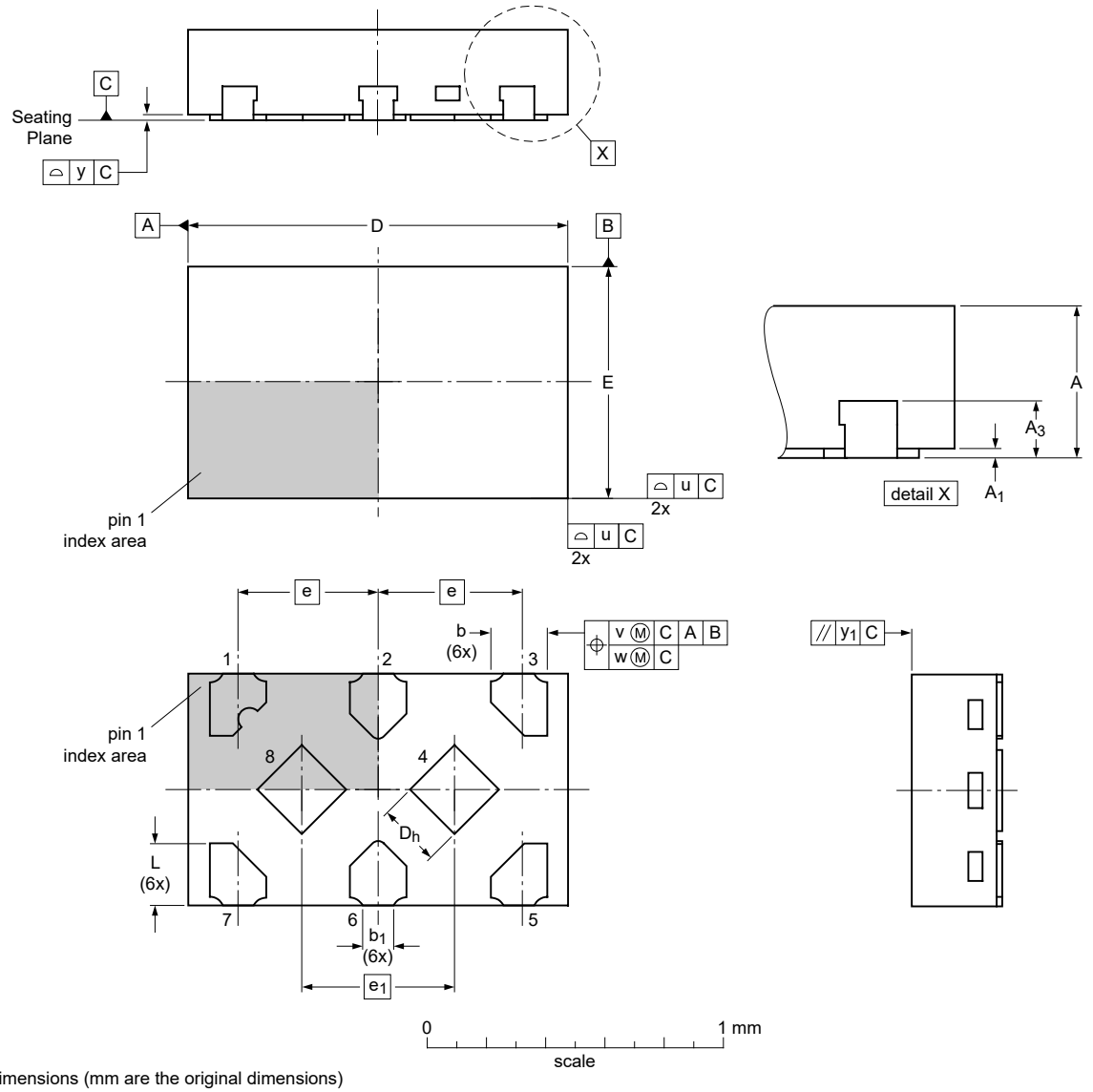
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

*sot1203_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT1203 | | | | | | ~~10-04-02~~ 10-04-06 |

**Fig. 9. Package outline SOT1203 (XSON8)**

**X2SON8: plastic thermal enhanced extremely thin small outline package; no leads; 8 terminals; body 1.35 x 0.8 x 0.32 mm** **SOT1233-2**




Dimensions (mm are the original dimensions)

| Unit | | A | $A_1$ | $A_3$ | b | $b_1$ | D | $D_h$ | E | e | $e_1$ | L | u | v | w | y | $y_1$ |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 0.35 | 0.04 | 0.10 (Typ.) | 0.25 | 0.11 (ref) | 1.35 | 0.27 | 0.80 | 0.50 | 0.54 | 0.27 | 0.05 | 0.10 | 0.05 | 0.05 | 0.05 |
| | nom | 0.32 | 0.02 | | 0.20 | | | 0.22 | | | | 0.22 | | | | | |
| | min | 0.30 | 0.00 | | 0.15 | | | 0.17 | | | | 0.17 | | | | | |

*sot1233-2_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT1233-2 | | --- | | | | 19-11-12 |

**Fig. 10. Package outline SOT1233-2 (X2SON8)**

## 13. Abbreviations

**Table 11. Abbreviations**

| Acronym | Description |
|---|---|
| ANSI | American National Standards Institute |
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| ESDA | ElectroStatic Discharge Association |
| HBM | Human Body Model |
| JEDEC | Joint Electron Device Engineering Council |

## 14. Revision history

**Table 12. Revision history**

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| 74AUP2G00 v.14 | 20240812 | Product data sheet | - | 74AUP2G00 v.13 |
| Modifications: | • Type number 74AUP2G00GM (SOT902-2/XQFN8) removed. | | | |
| 74AUP2G00 v.13 | 20240416 | Product data sheet | - | 74AUP2G00 v.12 |
| Modifications: | • Type number 74AUP2G00GF (SOT1089/XSON8) removed. | | | |
| 74AUP2G00 v.12 | 20230714 | Product data sheet | - | 74AUP2G00 v.11 |
| Modifications: | • Section 2: ESD specification updated according to the latest JEDEC standard. | | | |
| 74AUP2G00 v.11 | 20220609 | Product data sheet | - | 74AUP2G00 v.10 |
| Modifications: | • Table 5: Derating values for $P_{tot}$ total power dissipation have been updated.<br>• SOT1233 (X2SON8) package changed to SOT1233-2 (X2SON8) package. | | | |
| 74AUP2G00 v.10 | 20170703 | Product data sheet | - | 74AUP2G00 v.9 |
| Modifications: | • The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.<br>• Legal texts have been adapted to the new company name where appropriate.<br>• Section 6.1 and Fig. 10 (drawings SOT1233/X2SON8) updated<br>• Type number 74AUP2G00GD removed. | | | |
| 74AUP2G00 v.9 | 20161028 | Product data sheet | - | 74AUP2G00 v.8 |
| Modifications: | • Added type number 74AUP2G00GX (SOT1233/X2SON8) | | | |
| 74AUP2G00 v.8 | 20130205 | Product data sheet | - | 74AUP2G00 v.7 |
| Modifications: | • For type number 74AUP2G00GD XSON8U has changed to XSON8. | | | |
| 74AUP2G00 v.7 | 20120608 | Product data sheet | - | 74AUP2G00 v.6 |
| 74AUP2G00 v.6 | 20111201 | Product data sheet | - | 74AUP2G00 v.5 |
| 74AUP2G00 v.5 | 20101021 | Product data sheet | - | 74AUP2G00 v.4 |
| 74AUP2G00 v.4 | 20080605 | Product data sheet | - | 74AUP2G00 v.3 |
| 74AUP2G00 v.3 | 20080403 | Product data sheet | - | 74AUP2G00 v.2 |
| 74AUP2G00 v.2 | 20070515 | Product data sheet | - | 74AUP2G00 v.1 |
| 74AUP2G00 v.1 | 20060825 | Product data sheet | - | - |

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## Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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